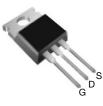


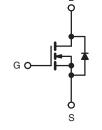


D Series Power MOSFET

PRODUCT SUMMARY				
V_{DS} (V) at T_{J} max.	450			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.17		
Q _g max. (nC)	88			
Q _{gs} (nC)	12			
Q _{gd} (nC)	23			
Configuration	Single			

TO-220AB





N-Channel MOSFET

FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Compliant to RoHS Directive 2011/65/EU

Note

Pb containing terminations are not RoHS compliant, exemptions may apply

APPLICATIONS

- Consumer Electronics Displays (LCD or Plasma TV)
- Lighting Industrial
 - Welding

 - Induction Heating - Motor Drives

 - Battery Chargers
- SMPS

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP25N40D-E3
Lead (Pb)-free and Halogen-free	SiHP25N40D-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	400			
Gate-Source Voltage			± 30	V	
Gate-Source Voltage AC (f > 1 Hz)	V _{GS}	30			
Continuous Drain Current (T _J = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	- I _D -	25	А	
	V_{GS} at 10 V $T_C = 100 \text{ °C}$		16		
Pulsed Drain Current ^a	I _{DM}	78			
Linear Derating Factor			2.2	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	556	mJ	
Maximum Power Dissipation		PD	278	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		24	1//20	
Reverse Diode dV/dt ^d		dV/dt	0.6	V/ns	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^c	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 2.3 mH, $R_q = 25 \Omega$, $I_{AS} = 17$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, starting $T_J = 25 \text{ °C}$.

S12-0625-Rev. B, 26-Mar-12



FREE Available

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.45				°C/W		
		•						
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	T CONDIT	ONS	MIN.	TYP.	MAX.	UNIT
Static		·						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	250 µA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, $I_D = 250 \ \mu A$		-	0.5	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3	-	5	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} =	V _{DS} = 400 V, V _{GS} = 0 V		-	-	1	μA
	I _{DSS}	V _{DS} = 320 \	V _{DS} = 320 V, V _{GS} = 0 V, T _J = 125 °C		-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 13 A		-	0.14	0.17	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 13 A		-	7.4	-	S	
Dynamic					1	I	1	
Input Capacitance	C _{iss}	$V_{rec} = 0 V$			-	1707	-	
Output Capacitance	C _{oss}		V _{GS} = 0 V, V _{DS} = 100 V,		-	177	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	19	-	1	
Total Gate Charge	Qg				-	44	88	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$V_{GS} = 10 \text{ V}$ $I_D = 13 \text{ A}, \text{ V}_{DS} = 320 \text{ V}$		-	12	-	nC
Gate-Drain Charge	Q _{gd}				-	23	-	
Turn-On Delay Time	t _{d(on)}				-	21	42	
Rise Time	t _r	V _{DD} = 320 V, I _D = 13 A,		-	57	86	1	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	$V_{DD} = 320 V, I_D = 13 A,$ $V_{GS} = 10 V, R_g = 24.6 \Omega$		-	40	80	ns
Fall Time	t _f			-	37	74	1	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.8	-	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET sym showing the	MOSFET symbol showing the		-	-	24	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	78	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 13 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 13 \text{ A},$ dl/dt = 100 A/µs, V _R = 20 V			-	353	-	ns
Reverse Recovery Charge	Q _{rr}			-	4.4	-	uС	
Reverse Recovery Current	I _{RRM}				24		A	

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

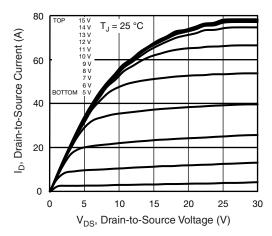


Fig. 1 - Typical Output Characteristics

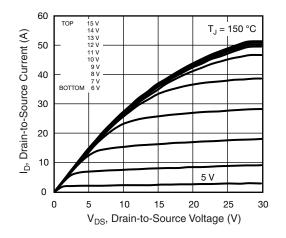


Fig. 2 - Typical Output Characteristics

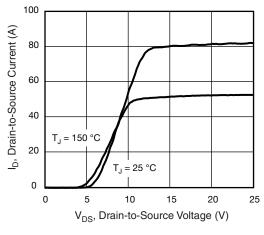


Fig. 3 - Typical Transfer Characteristics

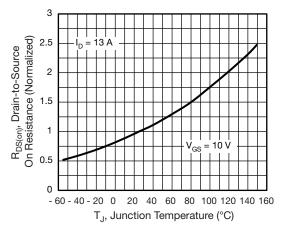


Fig. 4 - Normalized On-Resistance vs. Temperature

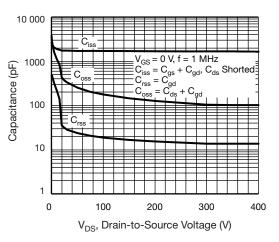


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

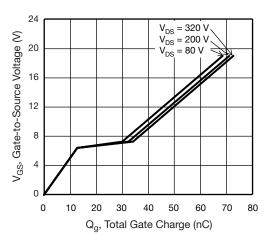


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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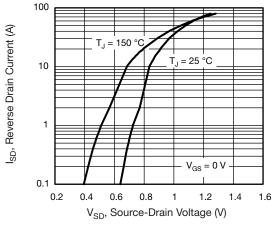
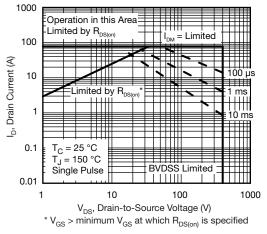
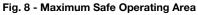


Fig. 7 - Typical Source-Drain Diode Forward Voltage





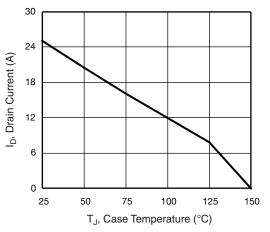


Fig. 9 - Maximum Drain Current vs. Case Temperature

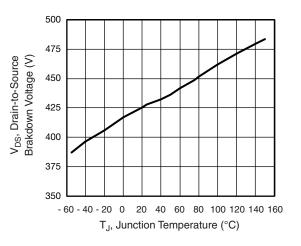
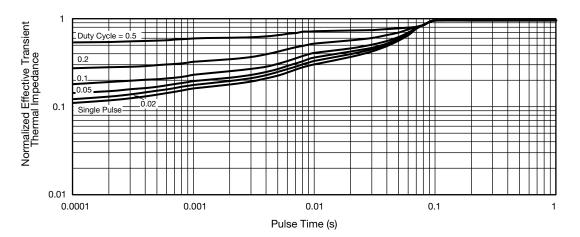


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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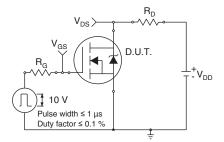


Fig. 12 - Switching Time Test Circuit



Fig. 13 - Switching Time Waveforms

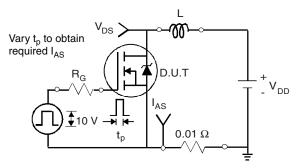


Fig. 14 - Unclamped Inductive Test Circuit

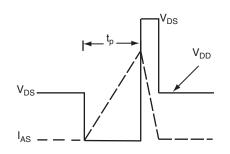


Fig. 15 - Unclamped Inductive Waveforms

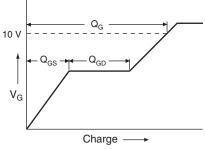


Fig. 16 - Basic Gate Charge Waveform

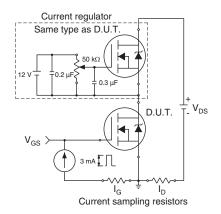


Fig. 17 - Gate Charge Test Circuit

5

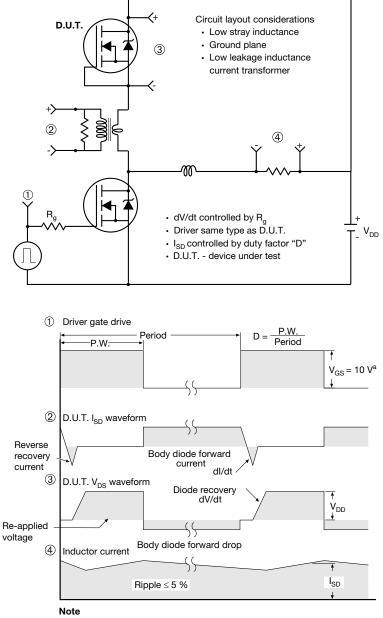
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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